

### General Description

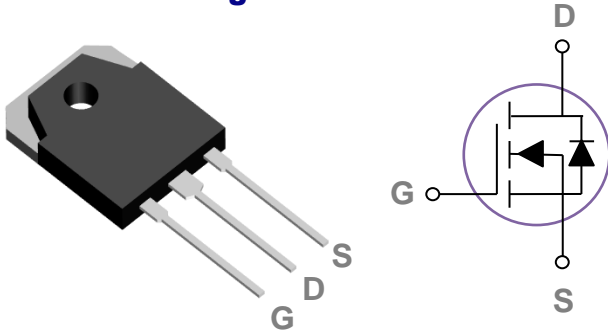
These N-Channel enhancement mode power field effect transistors are planar stripe, DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switch mode power supply

|       |       |     |
|-------|-------|-----|
| BVDSS | RDSON | ID  |
| 600V  | 0.6Ω  | 12A |

### Features

- 600V, 12A,  $R_{DS(ON)} = 0.6\Omega @ V_{GS} = 10V$
- Improved  $dv/dt$  capability
- Fast switching
- 100% EAS Guaranteed
- Green Device Available

### TO-3P Pin Configuration



### Applications

- High efficient switched mode power supplies
- TV Power
- Adapter/charger
- Server Power
- LED Lighting

### Absolute Maximum Ratings $T_c=25^\circ\text{C}$ unless otherwise noted

| Symbol    | Parameter  | Rating     | Units               |
|-----------|--|------------|---------------------|
| $V_{DS}$  | Drain-Source Voltage                                   | 600        | V                   |
| $V_{GS}$  | Gate-Source Voltage                                    | $\pm 30$   | V                   |
| $I_D$     | Drain Current – Continuous ( $T_c=25^\circ\text{C}$ )  | 12         | A                   |
|           | Drain Current – Continuous ( $T_c=100^\circ\text{C}$ ) | 7.6        | A                   |
| $I_{DM}$  | Drain Current – Pulsed <sup>1</sup>                    | 48         | A                   |
| EAS       | Single Pulse Avalanche Energy <sup>2</sup>             | 1051       | mJ                  |
| IAS       | Single Pulse Avalanche Current <sup>2</sup>            | 14.5       | A                   |
| $P_D$     | Power Dissipation ( $T_c=25^\circ\text{C}$ )           | 124        | W                   |
|           | Power Dissipation – Derate above $25^\circ\text{C}$    | 0.98       | W/ $^\circ\text{C}$ |
| $T_{STG}$ | Storage Temperature Range                              | -55 to 150 | $^\circ\text{C}$    |
| $T_J$     | Operating Junction Temperature Range                   | -55 to 150 | $^\circ\text{C}$    |

### Thermal Characteristics

| Symbol          | Parameter                              | Typ. | Max. | Unit                      |
|-----------------|--|------|------|---------------------------|
| $R_{\theta JA}$ | Thermal Resistance Junction to ambient | ---  | 62   | $^\circ\text{C}/\text{W}$ |
| $R_{\theta JC}$ | Thermal Resistance Junction to Case    | ---  | 1.01 | $^\circ\text{C}/\text{W}$ |

**Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)**
**Off Characteristics**

| Symbol            | Parameter                      | Conditions  | Min. | Typ. | Max. | Unit |
|-------------------|--------------------------------|---|------|------|------|------|
| BV <sub>DSS</sub> | Drain-Source Breakdown Voltage | V <sub>GS</sub> =0V, I <sub>D</sub> =250μA                        | 600  | ---  | ---  | V    |
| I <sub>DSS</sub>  | Drain-Source Leakage Current   | V <sub>DS</sub> =600V, V <sub>GS</sub> =0V, T <sub>J</sub> =25°C  | ---  | ---  | 1    | μA   |
|                   |                                | V <sub>DS</sub> =480V, V <sub>GS</sub> =0V, T <sub>J</sub> =125°C | ---  | ---  | 10   | μA   |
| I <sub>GSS</sub>  | Gate-Source Leakage Current    | V <sub>GS</sub> =±30V, V <sub>DS</sub> =0V                        | ---  | ---  | ±100 | nA   |

**On Characteristics**

|                     |                                   |  |     |     |     |   |
|---------------------|-----------------------------------|--|-----|-----|-----|---|
| R <sub>DS(ON)</sub> | Static Drain-Source On-Resistance | V <sub>GS</sub> =10V, I <sub>D</sub> =3A                 | --- | 0.5 | 0.6 | Ω |
| V <sub>GS(th)</sub> | Gate Threshold Voltage            | V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250μA | 2   | 3   | 4   | V |

**Dynamic and switching Characteristics<sup>3</sup>**

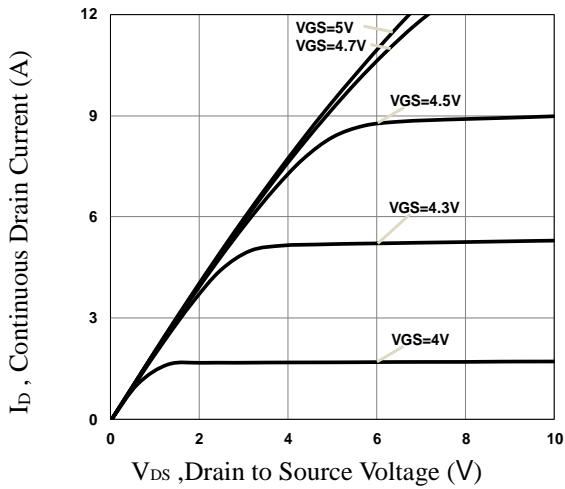
|                     |                              |   |     |      |      |    |
|---------------------|------------------------------|---|-----|------|------|----|
| Q <sub>g</sub>      | Total Gate Charge            | V <sub>DS</sub> =300V, V <sub>GS</sub> =10V, I <sub>D</sub> =6A                       | --- | 42   | 65   | nC |
| Q <sub>gs</sub>     | Gate-Source Charge           |   | --- | 6    | 10   |    |
| Q <sub>gd</sub>     | Gate-Drain Charge            |   | --- | 11.6 | 18   |    |
| T <sub>d(on)</sub>  | Turn-On Delay Time           | V <sub>DD</sub> =300V, V <sub>GS</sub> =10V, R <sub>G</sub> =6Ω<br>I <sub>D</sub> =6A | --- | 6    | 10   | ns |
| T <sub>r</sub>      | Rise Time                    |   | --- | 10   | 15   |    |
| T <sub>d(off)</sub> | Turn-Off Delay Time          |   | --- | 15   | 25   |    |
| T <sub>f</sub>      | Fall Time                    |   | --- | 10   | 15   |    |
| C <sub>iss</sub>    | Input Capacitance            | V <sub>DS</sub> =300V, V <sub>GS</sub> =0V, F=1MHz                                    | --- | 1940 | 3000 | pF |
| C <sub>oss</sub>    | Output Capacitance           |   | --- | 47   | 75   |    |
| C <sub>rss</sub>    | Reverse Transfer Capacitance |   | --- | 6    | 10   |    |
| R <sub>g</sub>      | Gate resistance              | V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, F=1MHz                                      | --- | 0.9  | ---  | Ω  |

**Drain-Source Diode Characteristics and Maximum Ratings**

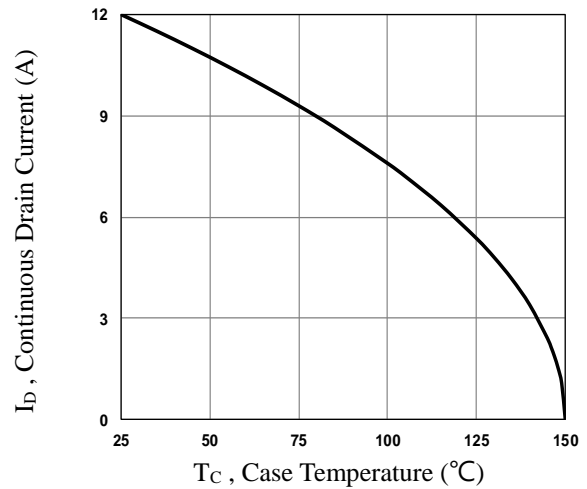
| Symbol          | Parameter                 | Conditions  | Min. | Typ. | Max. | Unit |
|-----------------|---------------------------|---|------|------|------|------|
| I <sub>S</sub>  | Continuous Source Current | V <sub>G</sub> =V <sub>D</sub> =0V, Force Current             | ---  | ---  | 12   | A    |
| I <sub>SM</sub> | Pulsed Source Current     |   | ---  | ---  | 24   | A    |
| V <sub>SD</sub> | Diode Forward Voltage     | V <sub>GS</sub> =0V, I <sub>S</sub> =1A, T <sub>J</sub> =25°C | ---  | ---  | 1    | V    |
| t <sub>rr</sub> | Reverse Recovery Time     | V <sub>R</sub> =400V, I <sub>S</sub> =10A                     | ---  | 370  | ---  | ns   |
| Q <sub>rr</sub> | Reverse Recovery Charge   | di/dt=100A/μs, T <sub>J</sub> =25°C                           | ---  | 4.4  | ---  | μC   |

Note :

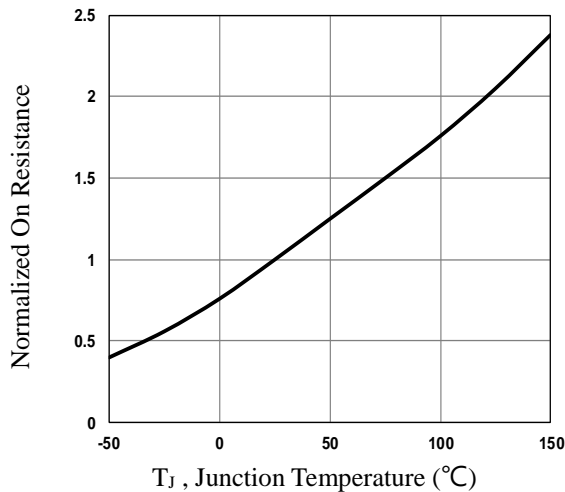
1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. V<sub>DD</sub>=50V, V<sub>GS</sub>=10V, L=10mH, I<sub>AS</sub>=14.5A, R<sub>G</sub>=25Ω, Starting T<sub>J</sub>=25°C.
3. Essentially independent of operating temperature.



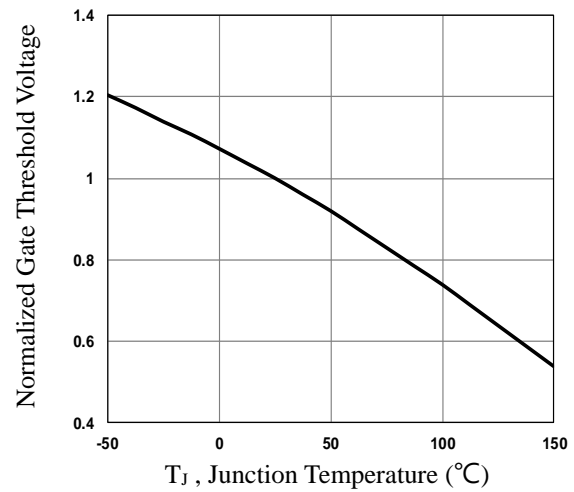
**Fig.1 Typical Output Characteristics**



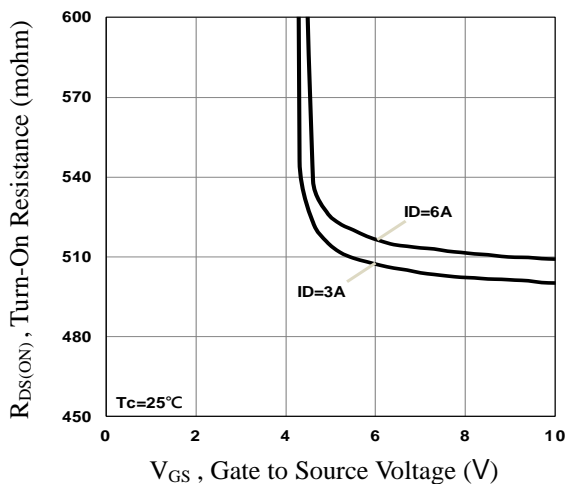
**Fig.2 Continuous Drain Current vs. T<sub>c</sub>**



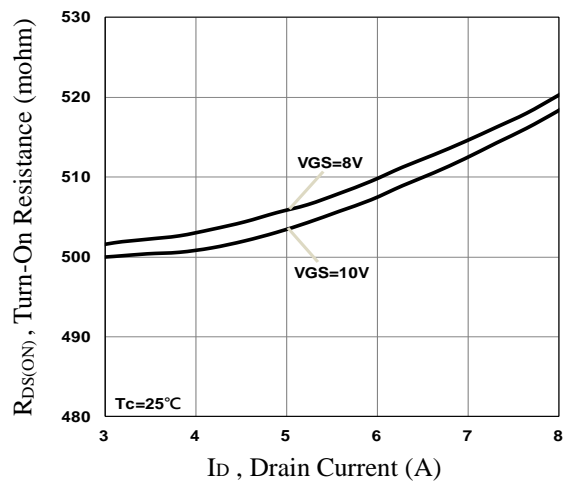
**Fig.3 Normalized R<sub>DS(on)</sub> vs. T<sub>j</sub>**



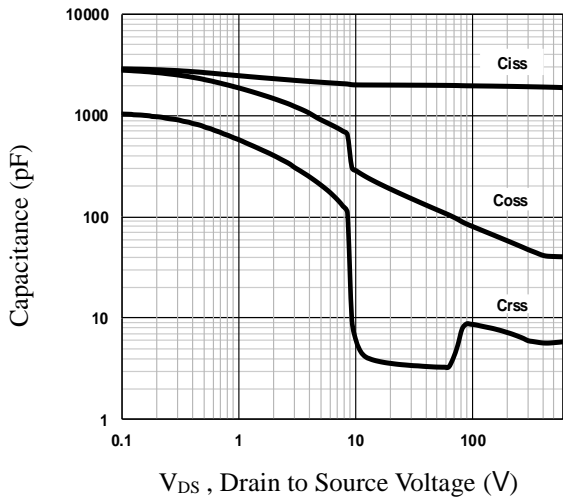
**Fig.4 Normalized V<sub>th</sub> vs. T<sub>j</sub>**



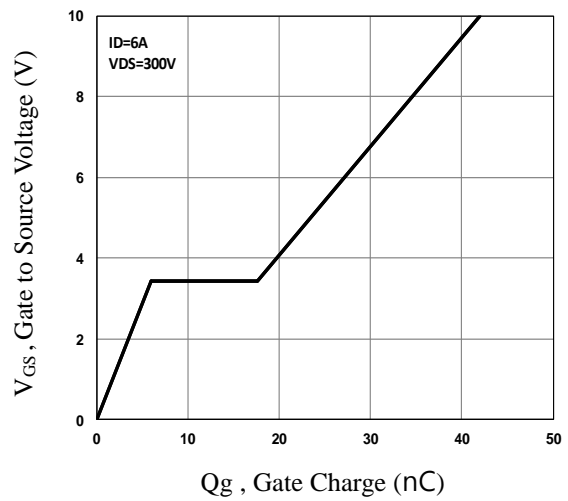
**Fig.5 Turn-On Resistance vs. V<sub>GS</sub>**



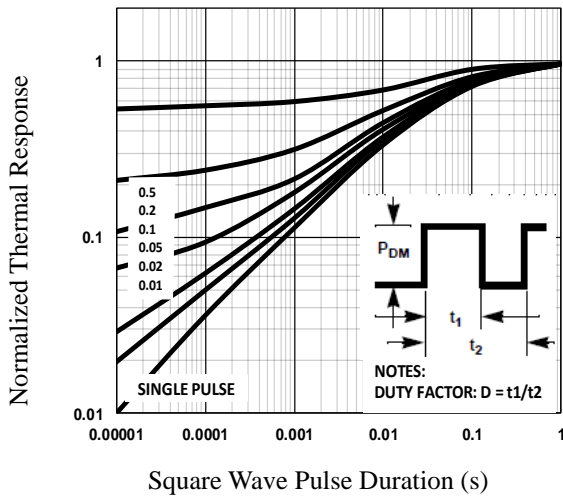
**Fig.6 Turn-On Resistance vs. I<sub>D</sub>**



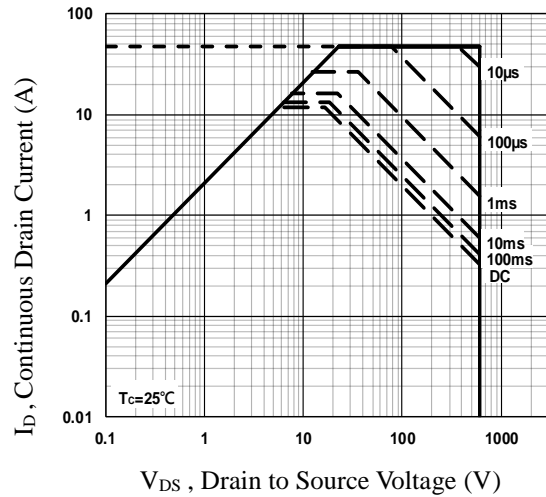
**Fig.7 Capacitance Characteristics**



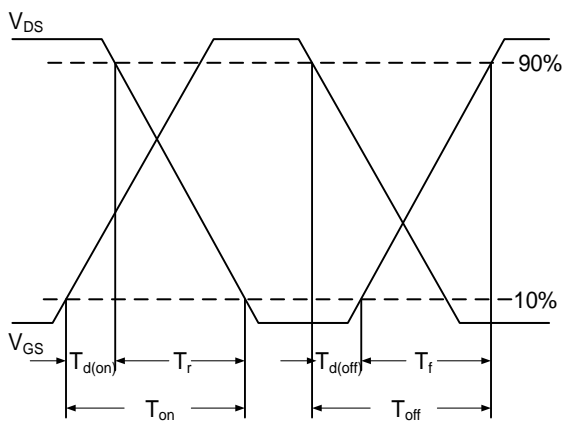
**Fig.8 Gate Charge Characteristics**



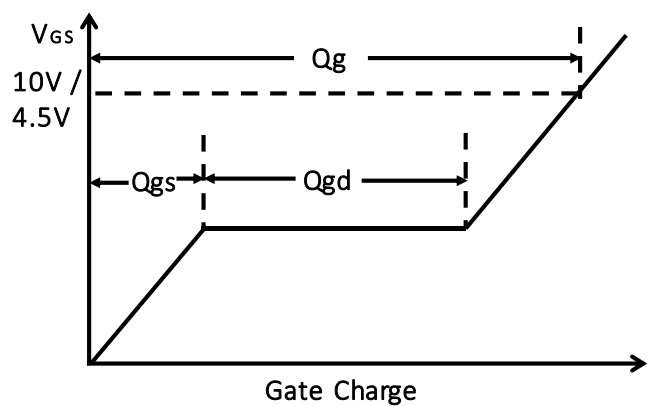
**Fig.9 Normalized Transient Impedance**



**Fig.10 Maximum Safe Operation Area**

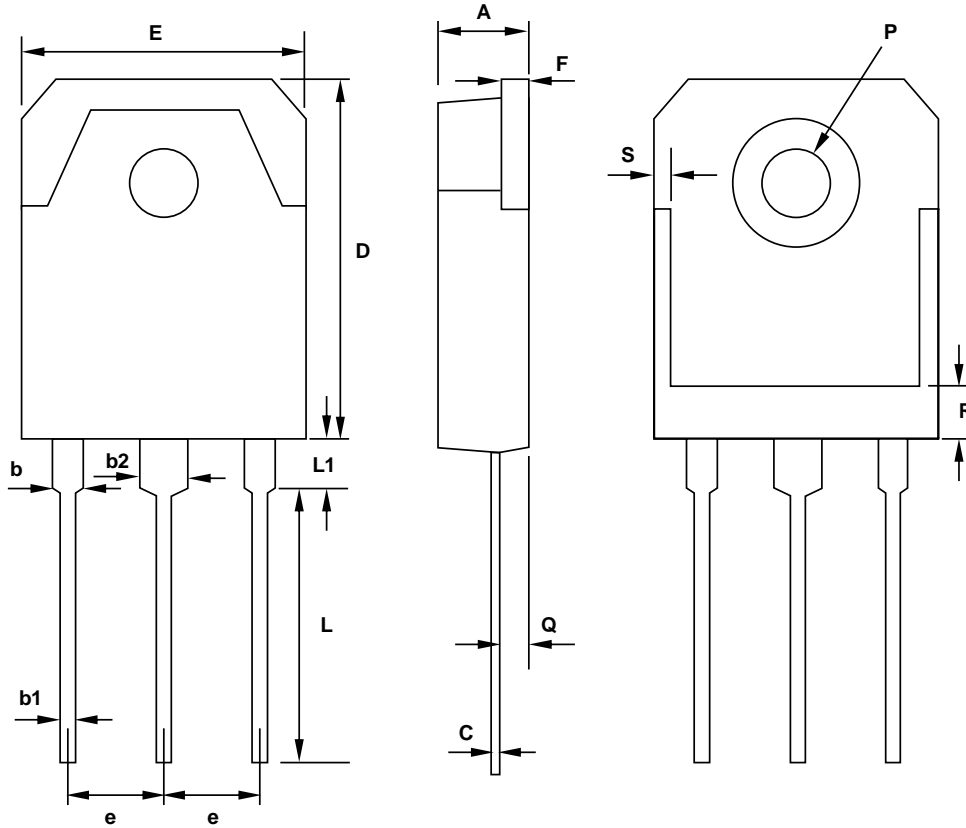


**Fig.11 Switching Time Waveform**



**Fig.12 Gate Charge Waveform**

TO-3P PACKAGE INFORMATION



| SYMBOL | mm    |       | SYMBOL | mm        |       |
|--------|-------|-------|--------|-----------|-------|
|        | MIN   | MAX   |        | MIN       | MAX   |
| A      | 4.600 | 5.000 | e      | 5.450 BSC |       |
| b      | 1.800 | 2.200 | L      | 16.20     | 16.80 |
| b1     | 0.900 | 1.100 | L1     | 3.500 REF |       |
| b2     | 2.800 | 3.200 | P      | 3.300 REF |       |
| C      | 0.500 | 0.700 | R      | 3.100 REF |       |
| D      | 19.70 | 20.10 | S      | 1.000 REF |       |
| E      | 15.40 | 15.80 | Q      | 1.400 REF |       |
| F      | 1.400 | 1.700 |        |           |       |